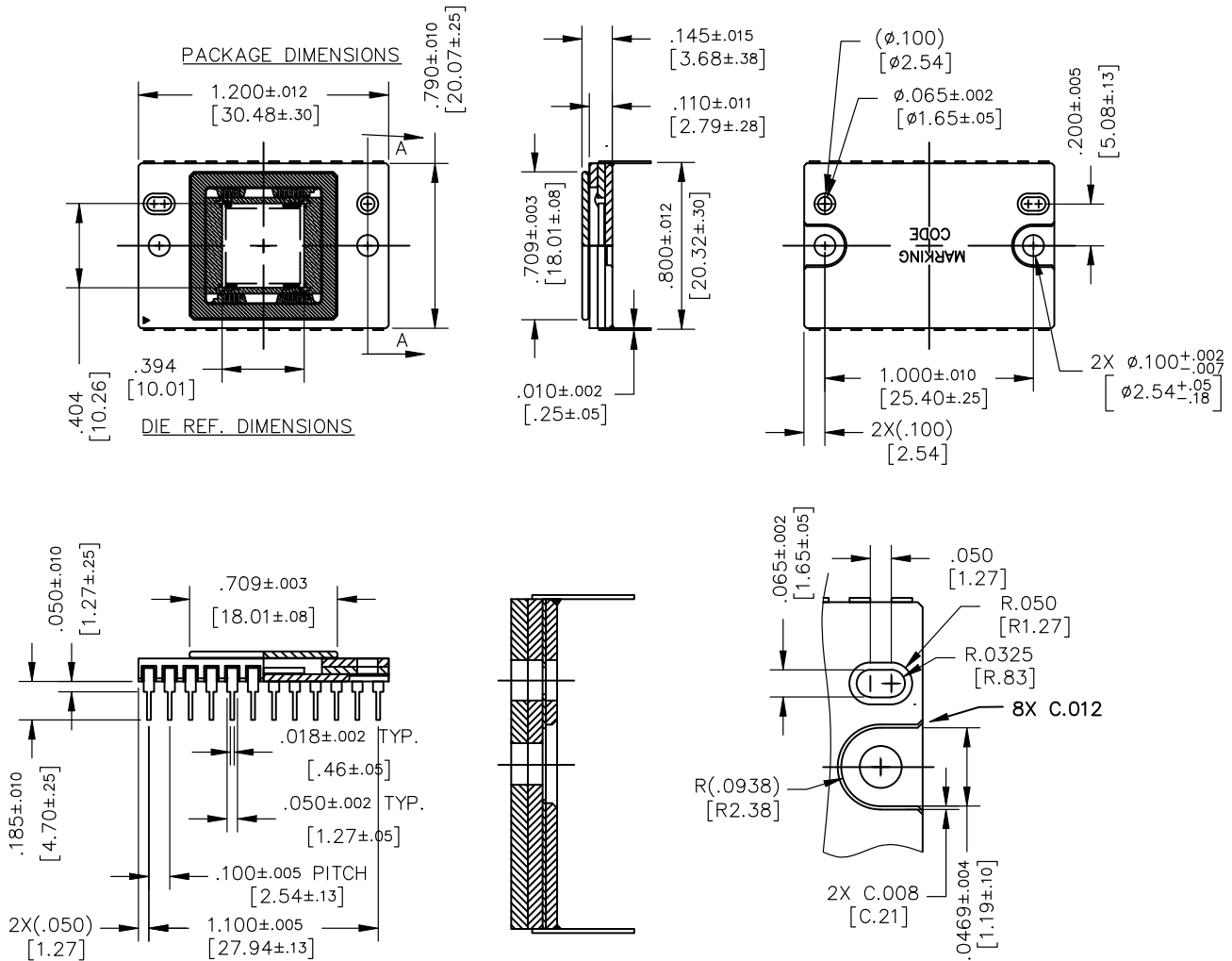


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Notes:
 1. Cover glass is manually placed and visually aligned over die – Location accuracy is not guaranteed.

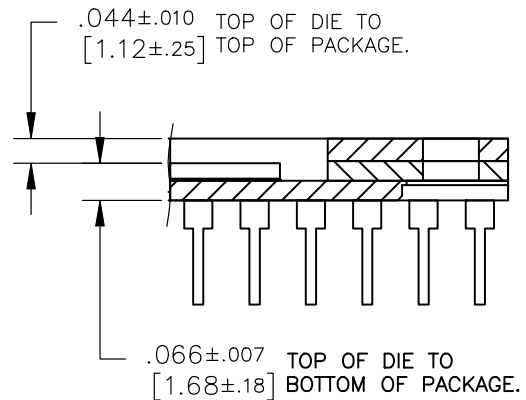
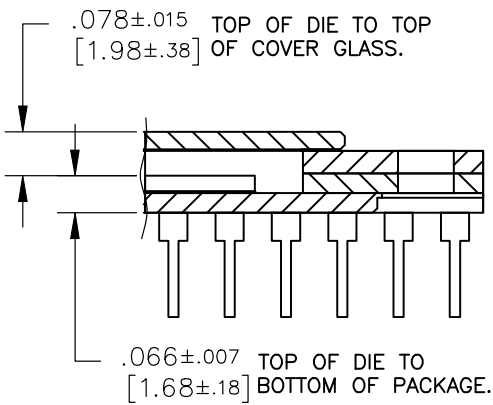
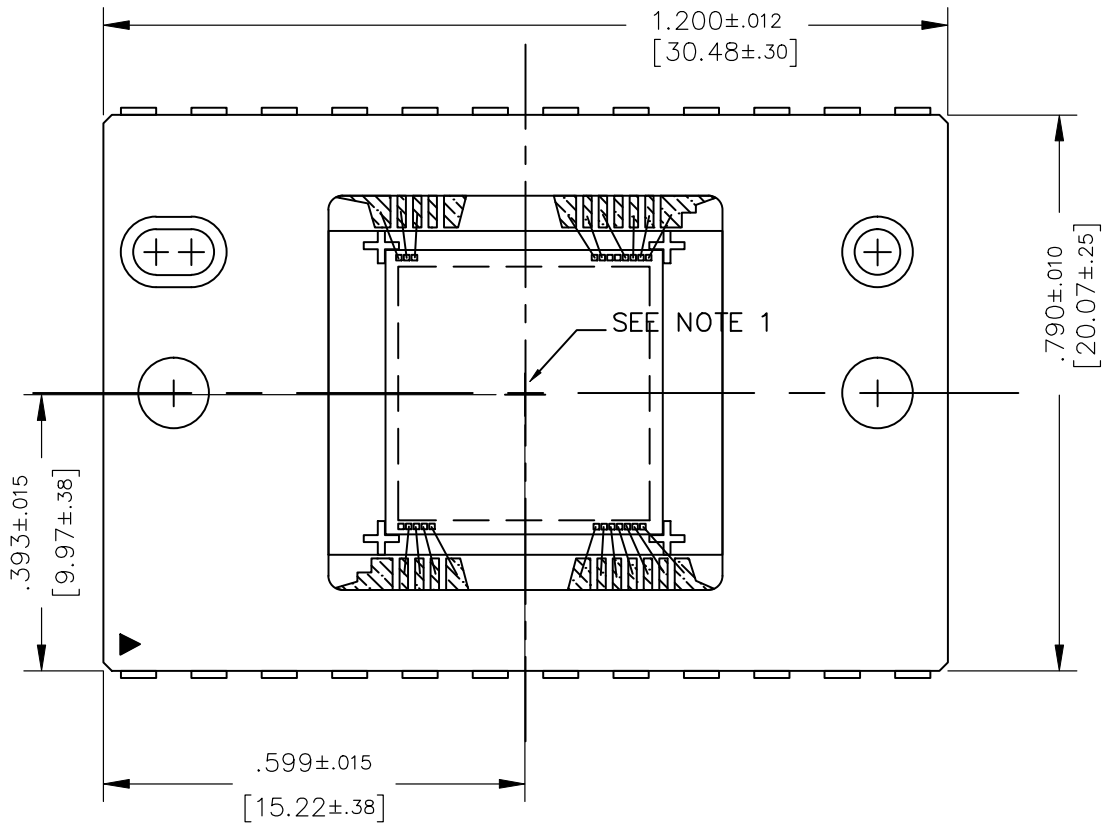
Dimensions in: Inches [mm]

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NOTES:

1. CENTER OF IMAGE AREA IS OFFSET FROM CENTER OF PACKAGE BY (-0.02,-0.06)MM NOMINAL.
2. DIE IS ALIGNED WITHIN +/- 2 DEGREE OF ANY PACKAGE CAVITY EDGE.

Dimensions in: Inches [mm]

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